

April 2000 Revised January 2005

NC7WZ32

TinyLogic® UHS Dual 2-Input OR Gate

General Description

The NC7WZ32 is a dual 2-Input OR Gate from Fairchild's Ultra High Speed Series of TinyLogic®. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V V_{CC} range. The inputs and output are high impedance when V_{CC} is 0V. Inputs tolerate voltages up to 7V independent of V_{CC} operating voltage.

Features

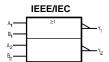
- Space saving US8 surface mount package
- MicroPak™ Pb-Free leadless package
- Ultra high speed t_{PD} 2.4 ns Typ into 50 pF at 5V V_{CC}
- High output drive ±24 mA at 3V V_{CC}
- Broad V_{CC} operating range 1.65V to 5.5V
- \blacksquare Matches the performance of LCX when operated at 3.3V V_{CC}
- Power down high impedance inputs/output
- Overvoltage tolerant inputs facilitate 5V to 3V translation
- Patented noise/EMI reduction circuitry implemented

Ordering Code:

Order Number	Package Number	Product Code Top Mark		Supplied As
NC7WZ32K8X	MAB08A	WZ32	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3k Units on Tape and Reel
NC7WZ32L8X	MAC08A	N5	Pb-Free 8-Lead MicroPak, 1.6 mm Wide	5k Units on Tape and Reel

Pb-Free package per JEDEC J-STD-020B

Logic Symbol



Pin Descriptions

Pin Names	Description
A _n , B _n	Inputs
Yn	Output

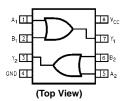
Function Table

Y = A + B

lnı	Output					
Α	A B					
L	L	L				
L	Н	Н				
Н	L	Н				
Н	Н	Н				

H = HIGH Logic Level

Connection Diagrams



Pin One Orientation Diagram



AAA represents Product Code Top Mark - see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Thru View)

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Absolute Maximum Ratings(Note 1)

 $@V_{IN} < -0.5V$ -50 mA

DC Output Diode Current (IOK)

Junction Lead Temperature (T_L);

Soldering, 10 seconds 260°C Power Dissipation (PD) @ +85°C 250 mW

Recommended Operating Conditions (Note 2)

Input Rise and Fall Time (t_r, t_f)

 $V_{CC} = 1.80V \pm 0.15V, 2.5V \pm 0.2V \qquad 0 \text{ ns/V to } 20 \text{ ns/V} \\ V_{CC} = 3.3V \pm 0.3V \qquad 0 \text{ ns/V to } 10 \text{ ns/V} \\ V_{CC} = 5.0V \pm 0.5V \qquad 0 \text{ ns/V to } 5 \text{ ns/V} \\ \text{Thermal Resistance } (\theta_{JA}) \qquad 250^{\circ}\text{C/W}$

Note 1: Absolute Maximum Ratings are DC values beyond which the device may be damaged or have its useful life impaired. The datasheet specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside datasheet specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

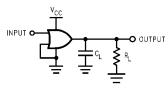
Symbol	Parameter	V _{CC}		T _A = +25°C		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Symbol	Farameter	(V)	Min	Тур	Max	Min	Max	Units	Conditions	
V _{IH}	HIGH Level Input Voltage	1.65 to 1.95	0.75 V _{CC}			0.75 V _{CC}		V		
		2.3 to 5.5	$0.7~\mathrm{V_{CC}}$			0.7 V _{CC}		V		
V _{IL}	LOW Level Input Voltage	1.65 to 1.95			0.25 V _{CC}		0.25 V _{CC}	V		
		2.3 to 5.5			$0.3~V_{\rm CC}$		$0.3\mathrm{V_{CC}}$	v		
V _{OH}	HIGH Level Output Voltage	1.65	1.55	1.65		1.55				
		2.3	2.2	2.3		2.2		V	V – V	$V_{IN} = V_{IH} I_{OH} = -100 \ \mu A$
		3.0	2.9	3.0		2.9			AIN — AIH	
		4.5	4.4	4.5		4.4				
		1.65	1.29	1.52		1.29				$I_{OH} = -4 \text{ mA}$
		2.3	1.9	2.15		1.9				$I_{OH} = -8 \text{ mA}$
		3.0	2.4	2.80		2.4		V		$I_{OH} = -16 \text{ mA}$
		3.0	2.3	2.68		2.3				$I_{OH} = -24 \text{ mA}$
		4.5	3.8	4.20		3.8				$I_{OH} = -32 \text{ mA}$
V _{OL}	LOW Level Output Voltage	1.65		0.0	0.1		0.1			
		2.3		0.0	0.1		0.1	V		1004
		3.0		0.0	0.1		0.1	V	AIN — AIT	$I_{OL} = 100 \mu A$
		4.5		0.0	0.1		0.1			
		1.65		0.08	0.24		0.24			$I_{OL} = 4 \text{ mA}$
		2.3		0.10	0.3		0.3			$I_{OL} = 8 \text{ mA}$
		3.0		0.15	0.4		0.4	V		$I_{OL} = 16 \text{ mA}$
		3.0		0.22	0.55		0.55			$I_{OL} = 24 \text{ mA}$
		4.5		0.22	0.55		0.55			$I_{OL} = 32 \text{ mA}$
I _{IN}	Input Leakage Current	0 to 5.5			±0.1		±1	μΑ	$V_{IN} = 5.5V$, GND
I _{OFF}	Power Off Leakage Current	0.0			1		10	μΑ	V _{IN} or V _{OI}	_{JT} = 5.5V
I _{CC}	Quiescent Supply Current	1.65 to 5.5			1		10	μΑ	$V_{IN} = 5.5V$, GND

AC Electrical Characteristics

Symbol	Parameter	V _{CC}	T _A = +25°C			$T_A = -40^{\circ}C$ to $+85^{\circ}C$		Units	Conditions	Figure
	i arameter	(V)	Min	Тур	Max	Min	Max	Oilles	Conditions	Number
t _{PLH} ,	Propagation Delay	1.8 ± 0.15	2.0	5.8	10.5	2.0	11.0			
t _{PHL}		2.5 ± 0.2	1.0	3.5	5.8	1.0	6.2	ns	$C_L = 15 pF$,	Figures 1, 3
		3.3 ± 0.3	0.8	2.6	3.9	0.8	4.3	115	$R_L = 1M\Omega$	
		5.0 ± 0.5	0.5	1.8	3.1	0.5	3.3			
t _{PLH} ,	Propagation Delay	3.3 ± 0.3	1.2	3.2	4.8	1.2	5.2	ns	$C_L = 50 \text{ pF},$	Figures
t _{PHL}		5.0 ± 0.5	0.8	2.4	3.7	0.8	4.0	115	$R_L = 500\Omega$	1, 3
C _{IN}	Input Capacitance	0		2.5				pF		
C _{PD}	Power Dissipation	3.3		14				pF	(Note 3)	Figure 2
	Capacitance	5.0		18				PΓ	(Note 3)	i igule 2

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC} static)$.

AC Loading and Waveforms



C_L includes load and stray capacitance.

Input PRR = 1.0 MHz, $t_{\rm W}$ = 500 ns.

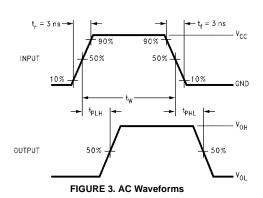
FIGURE 1. AC Test Circuit



Input = AC Waveforms; $t_f = t_f = 1.8 \text{ ns}$;

PRR = 10 MHz; Duty Cycle = 50%

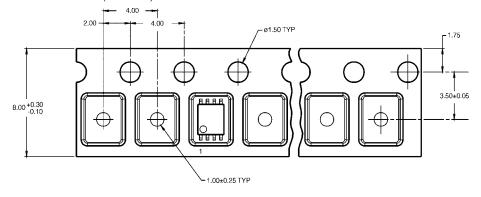
FIGURE 2. I_{CCD} Test Circuit



Tape and Reel Specification TAPE FORMAT for US8

17 ti = 1 0 1 till ti 101 t	=									
Package	Tape	Number	Cavity	Cover Tape						
Designator	Section	Cavities	Status	Status						
	Leader (Start End)	125 (typ)	Empty	Sealed						
K8X	Carrier	3000	Filled	Sealed						
	Trailer (Hub End)	75 (typ)	Empty	Sealed						

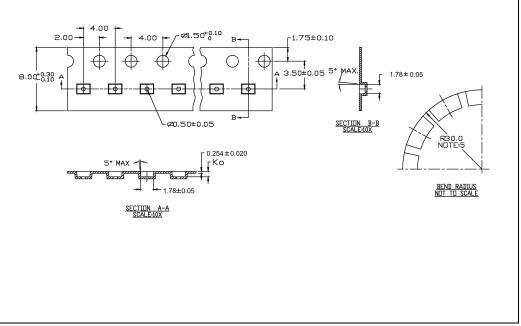
TAPE DIMENSIONS inches (millimeters)



TAPE FORMAT for MicroPak

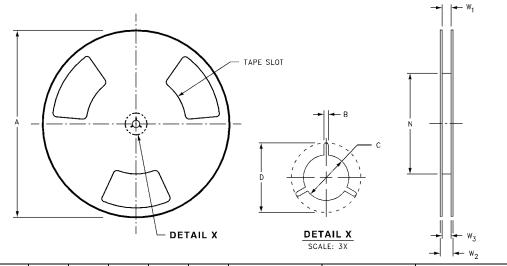
Package	Tape	Number	Cavity	Cover Tape Status	
Designator	Section	Cavities	Status		
	Leader (Start End)	125 (typ)	Empty	Sealed	
L8X	Carrier	3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

TAPE DIMENSIONS inches (millimeters)



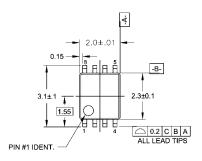
Tape and Reel Specification (Continued)

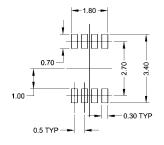
REEL DIMENSIONS inches (millimeters)



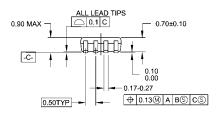
Tape Size	Α	В	С	D	N	W1	W2	W3
8 mm	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
0 111111	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

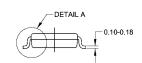
Physical Dimensions inches (millimeters) unless otherwise noted

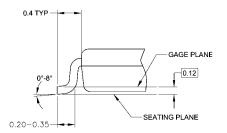




LAND PATTERN RECOMMENDATION







NOTES:

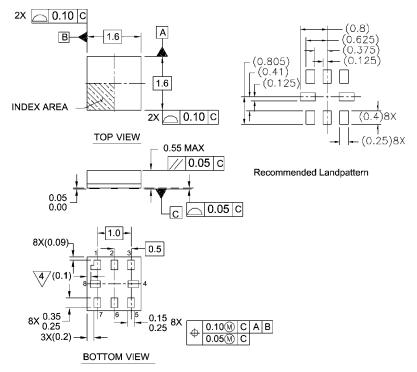
- A. CONFORMS TO JEDEC REGISTRATION MO-187 B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

DETAIL A

MAB08AREVC

8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide Package Number MAB08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

- 1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y.14M-1994
- 4/PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

Pb-Free 8-Lead MicroPak, 1.6 mm Wide Package Number MAC08A

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